



Mechanical Data

Case: SOT-26



DUAL N-CHANNEL ENHANCEMENT MODE FIELD EFFECT TRANSISTOR

Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0

Terminals: Finish - Matte Tin annealed over Copper

leadframe. Solderable per MIL-STD-202, Method 208

Moisture Sensitivity: Level 1 per J-STD-020C

Terminal Connections: See Diagram

Marking Information: See Page 4

Ordering Information: See Page 4

Weight: 0.015 grams (approximate)

Features

- **Dual N-Channel MOSFET**
- Low On-Resistance
- Very Low Gate Threshold Voltage (1.0V max)
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Small Surface Mount Package
- Lead Free By Design/RoHS Compliant (Note 2)
- ESD Protected up to 2kV
- "Green" Device (Note 4)
- Qualified to AEC-Q101 standards for High Reliability



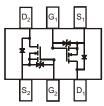




BOTTOM VIEW

TOP VIEW

SOT-26



TOP VIEW Internal Schematic

Maximum Ratings @T_A = 25°C unless otherwise specified

	Characteristic	Symbol	Value	Unit
Drain Source Voltage		V_{DSS}	50	V
Gate-Source Voltage		V_{GSS}	±20	V
Drain Current (Note 1)	Continuous	1-	305	m^
	Pulsed (Note 3)	ıD	800	mA

Thermal Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 1)	P _D	400	mW
Thermal Resistance, Junction to Ambient	$R_{ hetaJA}$	313	°C/W
Operating and Storage Temperature Range	T _i , T _{STG}	-65 to +150	°C

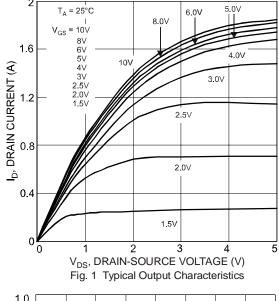
Electrical Characteristics @T_A = 25°C unless otherwise specified

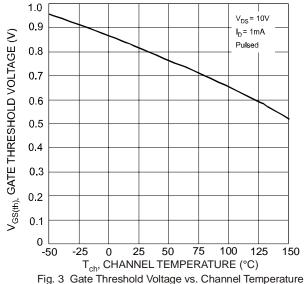
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 5)							•
Drain-Source Breakdown Voltage		BV _{DSS}	50	_	_	V	$V_{GS} = 0V, I_D = 10\mu A$
Zero Gate Voltage Drain Current	@ T _C = 25°C	I _{DSS}	_	_	60	nA	$V_{DS} = 50V, V_{GS} = 0V$
Gate-Body Leakage		I _{GSS}	_	_	1 500 50	μA nA nA	$V_{GS} = \pm 12V, V_{DS} = 0V$ $V_{GS} = \pm 10V, V_{DS} = 0V$ $V_{GS} = \pm 5V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 5)							
Gate Threshold Voltage		V _{GS(th)}	0.49	_	1.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
Static Drain-Source On-Resistance		R _{DS (ON)}	_	_ _ _	3.0 2.5 2.0	Ω	$V_{GS} = 1.8V$, $I_D = 50mA$ $V_{GS} = 2.5V$, $I_D = 50mA$ $V_{GS} = 5.0V$, $I_D = 50mA$
On-State Drain Current		I _{D(ON)}	0.5	1.4	_	Α	$V_{GS} = 10V, V_{DS} = 7.5V$
Forward Transconductance		Y _{fs}	200	_	_	mS	$V_{DS} = 10V, I_{D} = 0.2A$
Source-Drain Diode Forward Voltage		V _{SD}	0.5	_	1.4	V	$V_{GS} = 0V, I_{S} = 115mA$
DYNAMIC CHARACTERISTICS				•	•	•	
Input Capacitance		Ciss	_	_	50	pF	V 05V V 0V
Output Capacitance			_	_	25	pF	$V_{DS} = 25V, V_{GS} = 0V$ - f = 1.0MHz
Reverse Transfer Capacitance			_	_	5.0	pF	71 = 1.0101112

Notes:

- Device mounted on FR-4 PCB. 1.
- No purposefully added lead.
- Pulse width ≤10μS, Duty Cycle ≤1%.
- Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
 - Short duration pulse test used to minimize self-heating effect.







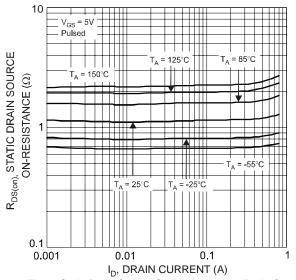
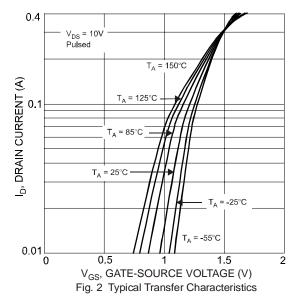


Fig. 5 Static Drain-Source On-Resistance vs. Drain Current



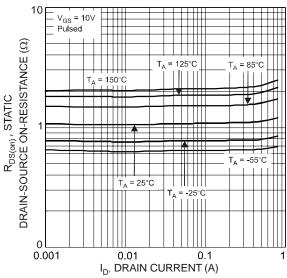


Fig. 4 Static Drain-Source On-Resistance vs. Drain Current

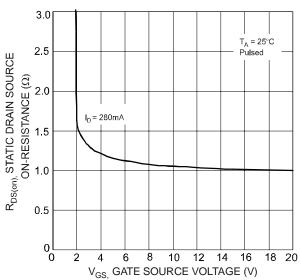


Fig. 6 Static Drain-Source On-Resistance vs. Gate-Source Voltage



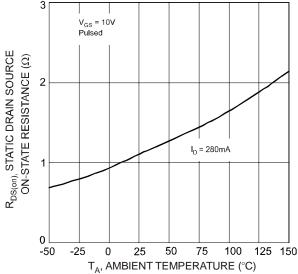


Fig. 7 Static Drain-Source On-State Resistance vs. Ambient Temperature

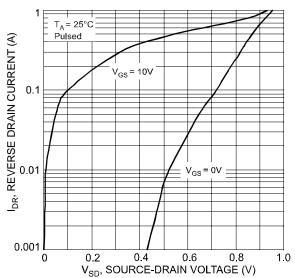
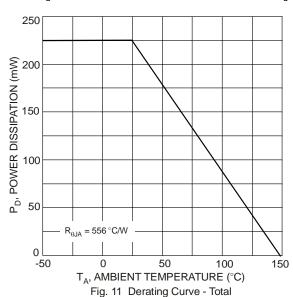


Fig. 9 Reverse Drain Current vs. Source-Drain Voltage



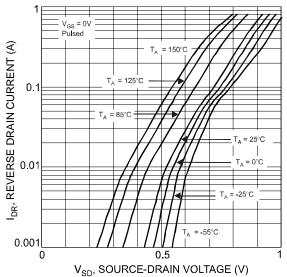


Fig. 8 Reverse Drain Current vs. Source-Drain Voltage

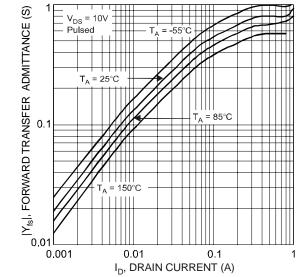


Fig.10 Forward Transfer Admittance vs. Drain Current



Ordering Information (Note 6)

Part Number	Case	Packaging
DMN5L06DMK-7	SOT-26	3000/Tape & Reel

Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information

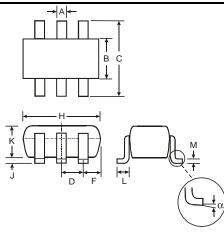


DAB = Marking Code YM = Date Code Marking Y = Year ex: T = 2006 M = Month ex: 9 = September

Date Code Key

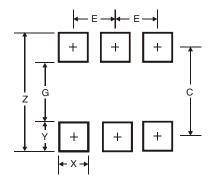
Year	200	6	2007		2008	20	09	2010		2011	2	2012
Code	Т		U		V	V	٧	Х		Υ		Z
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

Package Outline Dimensions



SOT-26					
Dim	Min	Max	Тур		
Α	0.35	0.50	0.38		
В	1.50	1.70	1.60		
С	2.70	3.00	2.80		
D	_	_	0.95		
F	-	-	0.55		
Н	2.90	3.10	3.00		
J	0.013	0.10	0.05		
K	1.00	1.30	1.10		
L	0.35	0.55	0.40		
М	0.10	0.20	0.15		
α	0°	8°	_		
All Dimensions in mm					

Suggested Pad Layout



Dimensions	Value (in mm)
Z	3.20
G	1.60
Х	0.55
Y	0.80
С	2.40
E	0.95

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